

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|---------|--|---|------------------|---------|------------------|
| L1 | 3220 | rewiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:09 |
| L2 | 3737 | rewiring re adj wiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:09 |
| L3 | 852469 | bump ball stud | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:10 |
| L4 | 1662223 | width | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:11 |
| L5 | 37152 | (rewir\$4 re adj wir\$4 redistribut\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:13 |
| L6 | 6225587 | (wiring wire metal metalization metallization conduct\$3 interconnect\$4 inter adj2 connect\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:14 |
| L7 | 56978 | 4 near3 6 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:15 |
| L8 | 486 | 3 with 7 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:15 |
| L9 | 1 | 8 same 1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:23 |

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|-----|---------|---|---|----|----|------------------|
| L10 | 3 | 8 and 1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:16 |
| L11 | 486 | 8 same 6 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:24 |
| L12 | 6 | 8 same 5 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:24 |
| S6 | 1 | 10/761310 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 10:41 |
| S7 | 2880 | rewiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:09 |
| S8 | 692374 | bump ball | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:10 |
| S9 | 4005921 | width area | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 10:53 |
| S10 | 8330670 | (narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 10:55 |
| S11 | 5574242 | ((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:25 |

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| S12 | 82813 | (bump ball) with ((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:27 |
| S13 | 1032769 | (width area) near3 ((narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:35 |
| S14 | 3 | "01120040" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:44 |
| S15 | 4 | 10/761310 "01120040" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:43 |
| S16 | 0 | "1989120040" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:45 |
| S17 | 0 | "1989120040" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:45 |
| S18 | 2 | "2001120040" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:47 |
| S19 | 985 | ((bump ball) with ((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((width area) near3 ((narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying))) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:47 |

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|-----|------|---|---|----|----|------------------|
| S20 | 7 | rewiring same (((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metallization metallization conduct\$3))) with ((width area) near3 ((narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying)))) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 12:50 |
| S21 | 12 | (((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metallization metallization conduct\$3))) with ((width area) near3 ((narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying)))) and rewiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 13:51 |
| S22 | 2211 | ((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metallization metallization conduct\$3))) same ((width area) near3 ((narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying))) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 13:52 |
| S23 | 139 | ((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metallization metallization conduct\$3))) and ((width area) near3 ((narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying))) and rewiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 13:52 |
| S24 | 22 | (((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metallization metallization conduct\$3))) same ((width area) near3 ((narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying)))) and rewiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 13:55 |

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|-----|-----|--|---|----|----|------------------|
| S25 | 119 | "3".clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 13:55 |
| S26 | 21 | ((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) and ((width area) near3 ((narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying))) and rewiring) and "3".clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 14:11 |
| S27 | 15 | ((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) same rewiring) and "3".clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 14:11 |
| S28 | 101 | ((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) same rewiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:00 |
| S29 | 1 | 10/052143 09/712105 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:08 |
| S30 | 2 | "6159837".pn. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:24 |
| S31 | 254 | ((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) and rewiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:25 |

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|-----|---------|---|---|----|----|------------------|
| S32 | 34 | "3".clm. and (((bump ball) with ((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) and rewiring) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:26 |
| S33 | 4186 | rewir\$4 re adj wir\$4 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 18:00 |
| S34 | 158 | "29".clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:33 |
| S35 | 347 | ((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) and (rewir\$4 re adj wir\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:33 |
| S36 | 47 | (((bump ball) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) and (rewir\$4 re adj wir\$4)) and "29".clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:55 |
| S37 | 680837 | land pad | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:56 |
| S38 | 1635 | (rewir\$4 re adj wir\$4) with ((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:57 |
| S39 | 4065607 | (insulat\$5 dielectric oxide) protect\$4 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:57 |

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|-----|------|--|---|----|----|------------------|
| S40 | 199 | ((rewir\$4 re adj wir\$4) with ((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((insulat\$5 dielectric oxide) protect\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 17:58 |
| S41 | 46 | "29".clm. and (((rewir\$4 re adj wir\$4) with (((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((insulat\$5 dielectric oxide) protect\$4)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 18:00 |
| S42 | 153 | ((((rewir\$4 re adj wir\$4) with ((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((insulat\$5 dielectric oxide) protect\$4)) not ("29".clm. and (((rewir\$4 re adj wir\$4) with ((multilevel\$4 multilayer\$4 (multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((insulat\$5 dielectric oxide) protect\$4))) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 18:00 |
| S43 | 1128 | "29".ab. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2004/09/20 18:00 |

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|-----|-------|--|---|----|----|------------------|
| S44 | 86 | ((((rewir\$4 re adj wir\$4) with ((multilevel\$4 multilayer\$4(multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((insulat\$5 dielectric oxide) protect\$4)) not ("29".clm. and (((rewir\$4 re adj wir\$4) with ((multilevel\$4 multilayer\$4(multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((insulat\$5 dielectric oxide) protect\$4)))) and "29".ab. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 07:39 |
| S45 | 4 | ((((rewir\$4 re adj wir\$4) with ((multilevel\$4 multilayer\$4(multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((insulat\$5 dielectric oxide) protect\$4)) not ("29".clm. and (((rewir\$4 re adj wir\$4) with ((multilevel\$4 multilayer\$4(multi\$4 plural\$4) adj (layer\$4 level\$4)) adj (interconnect\$4 (inter adj connect\$4))) (wiring wire metal metalization metallization conduct\$3))) with ((insulat\$5 dielectric oxide) protect\$4)))) and "29".ab. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 07:26 |
| S46 | 5 | "6545354".pn. "2003298005" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:00 |
| S47 | 321 | "WAKABAYASHI, TAKESHI".in. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:00 |
| S48 | 39905 | casio.as. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 12:58 |

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|-----|---------|--|---|----|----|------------------|
| S49 | 3534 | rewiring re-wiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:01 |
| S50 | 3540 | rewiring re adj wiring | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/05/06 17:09 |
| S51 | 6 | S50 not S49 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:03 |
| S52 | 57 | S47 and S48 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:03 |
| S53 | 6 | S52 and S50 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 12:28 |
| S54 | 4310509 | area thickness | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:06 |
| S55 | 715200 | bump ball | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:06 |
| S56 | 3219687 | larger greater | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:06 |
| S57 | 8569649 | (narrow\$2 wide\$2 big\$2 great\$2 large\$2 small\$2 thick\$2 thin\$2 different varying) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:09 |
| S58 | 6094765 | (wiring wire metal metalization metallization conduct\$3 interconnect\$4 inter adj2 connect\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 08:15 |

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|-----|---------|---|---|----|----|------------------|
| S59 | 4 | ((S57 near3 S54) with S50 with S58) same S55 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:10 |
| S60 | 1061983 | (S57 near3 S54) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:00 |
| S61 | 1483 | S50 with S58 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:21 |
| S62 | 16 | S60 with S61 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:21 |
| S63 | 36 | S60 same S61 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:21 |
| S64 | 12 | S63 same S55 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:22 |
| S65 | 15 | ("20020096757" "5117280" "5172212" "5569960" "5977641" "6103552" "6184062" "6285083" "6326701" "6329288" "6351035" "6387734" "6395164" "6400019" "6479900").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2005/01/21 09:44 |
| S66 | 35612 | (rewir\$4 re adj wir\$4 redistribut\$4) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:55 |
| S67 | 4582 | S66 with S58 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:57 |

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|-----|--------|--------------------------|---|----|----|------------------|
| S68 | 83 | S67 with S60 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 09:57 |
| S69 | 19 | S68 same S55 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 10:21 |
| S70 | 58 | S68 and S55 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 10:22 |
| S71 | 39 | S70 not S69 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 10:27 |
| S72 | 39 | S71 and S66 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 10:46 |
| S73 | 5 | "20020111009" "01120040" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 10:54 |
| S74 | 167107 | uppermost upper adj most | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 10:55 |
| S75 | 2986 | S74 adj2 S58 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 10:57 |
| S76 | 15 | S75 same S66 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 10:57 |
| S77 | 15 | S76 and S66 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 12:28 |
| S78 | 0 | ("6812565").URPN. | USPAT | OR | ON | 2005/01/21 12:34 |

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| S79 | 1 | ("6388318").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2005/01/21 12:34 |
| S80 | 0 | ("6545354").URPN. | USPAT | OR | ON | 2005/01/21 12:34 |
| S81 | 24 | ("4322778" "4617193" "4811082" "4903116" "5317433" "5530288" "5539241" "5770476" "5818079" "5928968" "5982018" "5990507" "6002161" "6025218" "6031293" "6108212" "6124606" "6140155" "6163456" "6180976" "6274937" "6331722" "6337517" "6362523").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2005/01/21 12:58 |
| S82 | 2922780 | width thickness | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 12:58 |
| S83 | 4176407 | "within" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 13:36 |
| S84 | 120214 | S58 near2 S82 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 14:31 |
| S85 | 2907 | S83 near8 S84 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 14:31 |
| S86 | 15 | S55 with S85 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 14:33 |
| S87 | 2 | S86 and S66 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/01/21 14:31 |